Docket No.: L&L-I0183

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : MANFRED GRESCHITZ ET AL.

Filed : CONCURRENTLY HEREWITH

Title : FINGERPRINT SENSOR WITH POTENTIAL MODULATION OF

THE ESD PROTECTIVE GRATING

## INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

- U.S. Patent No. 6,069,970 (Salatino et al.), dated May 30, 2000;
- U.S. Patent No. 6,055,324 (Fujieda), dated April 25, 2000;
- U.S. Patent Application Publication No. 2001/0022337 A1 (Basse et al.), dated September 20, 2001, and corresponding German Patent DE 198 36 770 C1 (Basse et al.), dated April 20, 2000;
- U.S. Patent Application Publication No. 2002/0066942 A1 (Opolka et al.), dated June 6, 2002, and corresponding German Published Non-Prosecuted Patent Application DE 199 01 384 A1 (Scheiter et al.), dated July 27, 2000;

German Published Non-Prosecuted Patent Application DE 198 44 145 A1 (Basse et al.), dated January 5, 2000, and English abstract thereof;

Patent Abstracts of Japan 08305832 A (Shigeto et al.), dated November 22, 1996;

European Patent Application EP 0 902 387 A2 (Kalnitsky et al.), dated March 17, 1999;

European Patent Application EP 1 059 602 A1 (Morimura et al.), dated December 13, 2000;

PCT WO 00/42657 (Opolka et al.), dated July 20, 2000;

PCT WO 00/10205 (Von Basse et al.), dated February 24, 2000;

Inglis, D. et al.: "SA 17.7: A Robust 1.8V 250µW Direct-Contact 500dpi Fingerprint Sensor", IEEE International Solid-State Circuits Conference, 1998, pp. 284-285;

International Search Report, dated August 7, 2002.

If no translation of pertinent portions of any foreign language patents or publications mentioned above is included with the aforementioned copies of those applications, patents and/or publications, it is because no existing translation is readily available to the applicant.

Respectfully submitted

REG. NO. 29,308

For Applicants

Date: September 8, 2003

Lerner and Greenberg, P.A. Post Office Box 2480

Hollywood, FL 33022-2480

Tel: (954) 925-1100 Fax: (954) 925-1101

/nt/kf

FORM PTO-1449 (SUBSTITUTE)  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  INFORMATION DISCLOSURE STATEMENT BY APPLICANT (37 CFR 1.98(b))				Attorney Docket No.: L&L-I0183 Appl. No.:  Applicant: MANFRED GRESCHITZ ET AL.  Filing Date: September 8, 2003				
<u> </u>				Group Art Unit:				
}								
EXAMINER INITIALS		PATENT NO.	DATE	PATENTEE	CLASS	SUB CLASS		ING TE
	Α	6,069,970	5/30/00	Salatino et al.				
	В	6,055,324	4/25/00	Fujieda				
	С	20010022337A1	9/20/01	Basse et al.				
	D	20020066942A1	6/6/02	Opolka et al.				
	E							
	F							
	G							
	Н							
	1							
	•	FOREIG	N PATE	NT DOCUMENT	-			
		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB CLASS		NSL.   NO
	J	198 36 770 C1	4/20/00	Germany				
	K	199 01 384 A1	7/27/00	Germany				
	L	198 44 145 A1	1/5/00	Germany				
	М	08305832 A	11/22/96	Japan				
	N	0 902 387 A2	3/17/99	Europe				
OTHER	R DOC	CUMENTS (Inclu	ding Auth	or, Title, Date, I	Pertinent	Pages,	etc.)	
	<del> </del>					<del></del>		
EXAMINER				DATE CONSIDERED				

FORM PTO-1449 (SUBSTITUTE)				Attorney Docket No.: L&L-I0183 Appl. No.:						
U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE										
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (37 CFR 1.98(b))				Applicant: MANFRED GRESCHITZ ET AL.						
			Filing Date: September 8, 2003 Group Art Unit:							
			<del></del>							
EXAMINER INITIALS		PATENT NO.	DATE	PATENTEE	CLASS	SUB CLASS	FILI			
	Α					32,,33				
	В									
	С									
	D									
	E									
	F									
	G			<u> </u>	<u> </u>					
	Н									
	1						L			
		FOREIG	N PATE	NT DOCUMENT						
		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB CLASS	TRAN YES			
<del></del>	J	1 059 602 A1	12/13/00	Europe	CLASS	CLASS	1231	NO		
	K	00/42657	7/20/00	WIPO				_		
·	L	00/10205	2/24/00	WIPO						
	М									
	N									
OTHER	DOC	CUMENTS (Inclu	ding Auth	nor, Title, Date, F	Pertinent	Pages,	etc.)			
		Inglis, D. et al.: "SA 17.7: A Robust 1.8V 250µW Direct-Contact 500dpi Fingerprint Sensor", IEEE International Solid-State Circuits Conference, 1998, pp. 284-285								
EXAMINER				DATE CONSIDERED						